

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

WPH4003 — General-Purpose Switching Device Applications

Features

- ON-resistance RDS (on) = 8.2Ω (typ.)
- Input Capacitance Ciss=850pF (typ.)
- 10V drive

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		1700	V
Gate-to-Source Voltage	V _{GSS}		±30	V
D 1 0 1 (D0)	I _{Dc} *1	Limited only maximum temperature Tch=150°C	3	А
Drain Current (DC)	I _{Dpack*2}	Tc=25°C (SANYO's ideal heat dissipation condition) *3	2.5	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	6	Α
Allowable Power Dissipation	D-		3.0	W
	PD	Tc=25°C	55	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *4	EAS		49	mJ
Avalanche Current *5	IAV		3	А

Note:*1 Shows chip capability

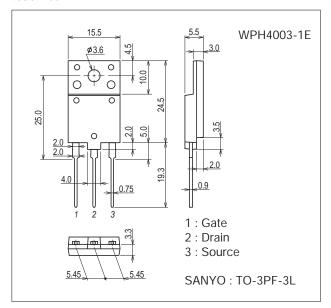
- *2 Package limited
- *3 SANYO's condition is radiation from backside.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminium.

- *4 VDD=50V, L=10mH, IAV=3A (Fig.1)
- *5 L≤10mH, single pulse

Package Dimensions

unit : mm (typ) 7538A-002



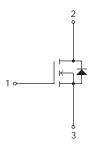
Product & Package Information

Package : TO-3PF-3LJEITA, JEDEC : SC-96

• Minimum Packing Quantity: 30 pcs./magazine

Marking Electrical Connection





Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	1700			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =1360V, V _{GS} =0V			1	mA	
Gate-to-Source Leakage Current	IGSS	V _{GS} =±30V, V _{DS} =0V			±100	nA	
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	2		4	V	
Forward Transfer Admittance	yfs	V _{DS} =20V, I _D =1.5A	1.2	2.4		S	
Static Drain-to-Source On-State Resistance	R _{DS} (on)	I _D =1.5A, V _G S=10V		8.2	10.5	Ω	
Input Capacitance	Ciss			850		pF	
Output Capacitance	Coss	V _{DS} =30V, f=1MHz		90		pF	
Reverse Transfer Capacitance	Crss			27		pF	
Turn-ON Delay Time	t _d (on)			19		ns	
Rise Time	t _r	Con Fire 2		21		ns	
Turn-OFF Delay Time	t _d (off)	See Fig.2		200		ns	
Fall Time	t _f			55		ns	
Total Gate Charge	Qg			48		nC	
Gate-to-Source Charge	Qgs	V _{DS} =200V, V _{GS} =10V, I _D =3A		6		nC	
Gate-to-Drain "Miller" Charge	Qgd	1		22		nC	
Diode Forward Voltage	V _{SD}	I _S =3A, V _{GS} =0V		0.8	1.5	V	
Reverse Recovery Time	t _{rr}	See Fig.3		410		ns	
Reverse Recovery Charge	Q _{rr}	IS=3A, VGS=0V, di/dt=100A/μs		3000		nC	

Fig.1 Unclamped Inductive Switching Test Circuit

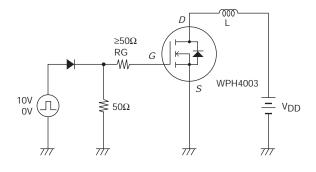


Fig.2 Switching Time Test Circuit

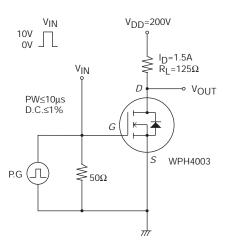
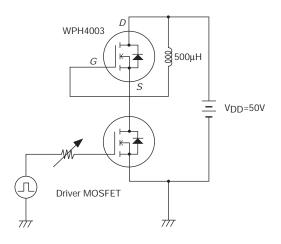
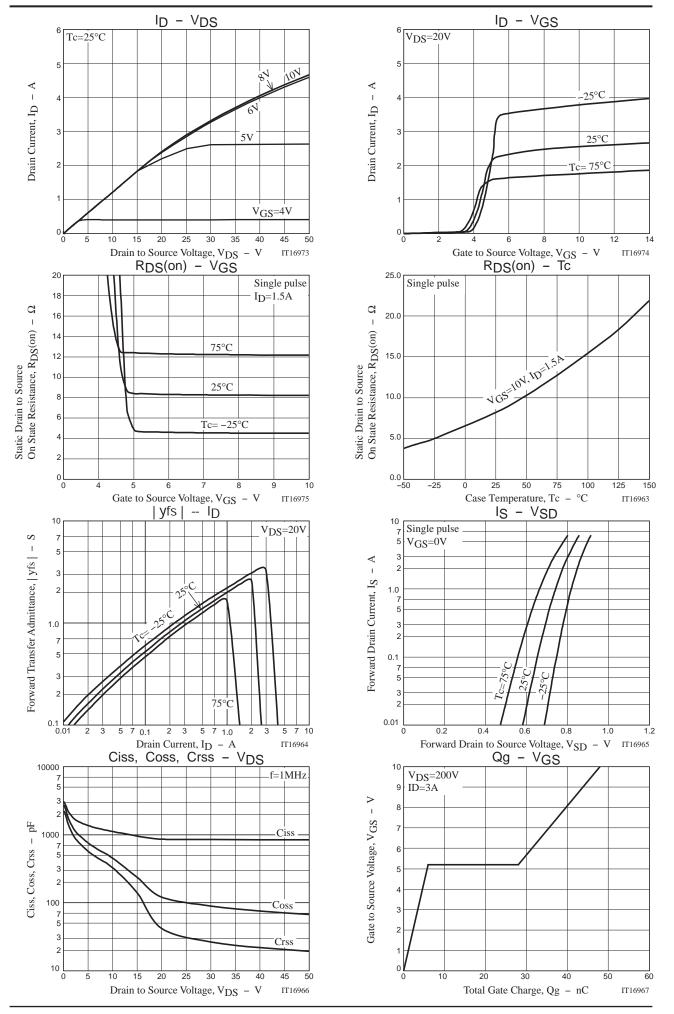


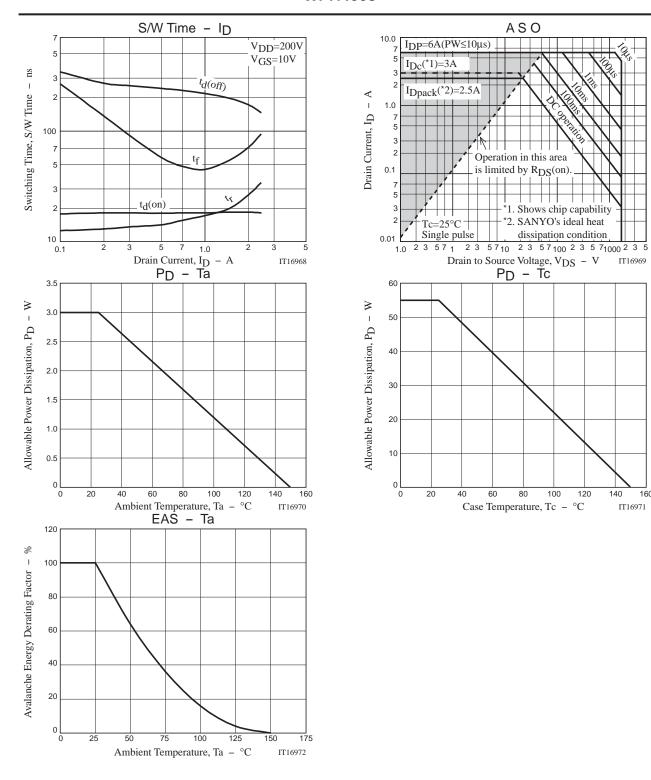
Fig.3 Reverse Recovery Time Test Circuit



Ordering Information

Device	Package	Shipping	memo	
WPH4003-1E	TO-3PF-3L	30pcs./magazine	Pb Free	





140

160

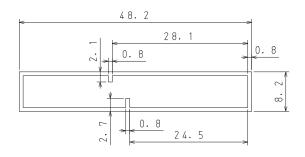
IT16971

Magazine Specification

WPH4003-1E

1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			Packing format		
I acuaso Mamo	Magazine	Inner box	Outer box	Inner BOX	Outer BOX	
TO-3PF-3L	30	360	1440	SPD-0V0001 12 magazines contained Dimensions:mm(external) 568×150×55	SPD-LV0010 4 inner boxes contained Dimensions:mm (external) 590x225x178	



Tolerance=±0.2mm
Thickness=0.8±0.2mm
Length =508.0±1mm
Material =PVC or PET
(Antistatic treatment)

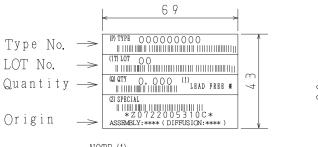
3. Storage method to magazine

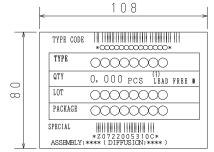


4. Inner box label (unit:mm)



It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



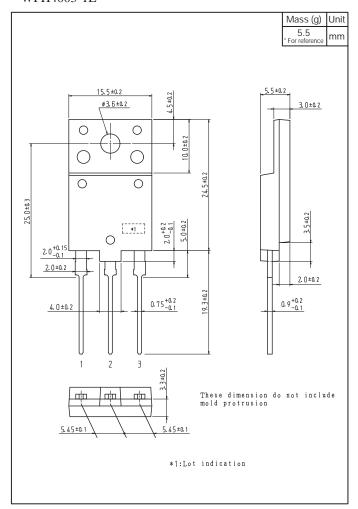


The LEAD FREE % description shows that the surface treatment of the terminal is lead free.

Label		JEITA Phase			
LEAD FRE	E 3	JEITA Phase 3A			

Outline Drawing

WPH4003-1E



Note on usage: Since the WPH4003 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment. The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for new introduction or other application different from current conditions on the usage of automotive device, communication device, office equipment, industrial equipment etc., please consult with us about usage condition (temperature, operation time etc.) prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- Regarding monolithic semiconductors, if you should intend to use this IC continuously under high temperature, high current, high voltage, or drastic temperature change, even if it is used within the range of absolute maximum ratings or operating conditions, there is a possibility of decrease reliability. Please contact us for a confirmation.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of November, 2012. Specifications and information herein are subject to change without notice.